H. Display and Imaging Technologies 분과 [TC2-H] Image Engineering & Sensors

TC2-H-1 10:45~11:15	[초청] Recent Technology Trends in Mobile Imaging Applications Jae-kyu Lee, Min-Woong Seo, Tae-Yon Lee, Myunglae Chu, Hyunchul Kim, JungChak Ahn, and Ho-kyu Kang Semiconductor R&D Center, Samsung Electronics Co., Ltd.
TC2-H-2 11:15~11:30	A Methodology for In-Fab Evaluation of Pinned Photodiode in CMOS Image Sensors Dongseok Cho, Sungin Kim, Jonghyun Go, Hyunchul Kim, Jaekyu Lee, and Jungchak Ahn Semiconductor R&D Center, Samsung Electronics Co., Ltd.
TC2-H-3 11:30~11:45	High-Sensitive And Transparent Strain Sensor Using Strain Engineered Substrate and Its Application For Human Motion Detection Inki Hwang, Daesik Kim, Geonhee Kim, and Yongtaek Hong Department of Electrical and Computer Engineering and Inter-University Semiconductor Research Center (ISRC), Seoul National University
TC2-H-4 11:45~12:00	Advanced Optical Collimator for Large Area OLED Fingerprint Sensor Ji Hun Ryu, Seung Hyun Moon, Chul Kim, Won Sang Park, and Bong-Hyun You Samsung Display Co., Ltd
TC2-H-5 12:00~12:15	2 Dimensional van der Waals Heterojunction Diode for Multiband Photo Detection Jongtae Ahn ^{1,2} , Hyun-soo Ra ¹ , and Do Kyung Hwang ¹ Center for Opto-electronic Materials and Devices, Post-silicon Semiconductor Institute, KIST, ² Yonsei University
TC2-H-6 12:15~12:30	Pressure-Sensitive Thin-Film Transistors Using Capacitance Modulation via Multiscale Surface Morphology of Embedded AgNWs Hayun Kim, Byeongmoon Lee, Hyunuk Oh, Hyunjun Yoo, Jaeyoung Yoon, and Yongtaek Hong Department of Electrical and Computer Engineering and Inter-University Semiconductor Research Center (ISRC), Seoul National University